



DMT6009LCT

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	Ι <sub>D</sub> T <sub>C</sub> = +25°C		
60V	12mΩ @V <sub>GS</sub> = 10V	37.2A		
	14.5mΩ @V <sub>GS</sub> = 4.5V	33.9A		

## **Description and Applications**

This new generation MOSFET features low on-resistance and fast switching, making it ideal for high-efficiency power management applications.

- DC-DC Converters
- Power Management Functions
- Load Switch

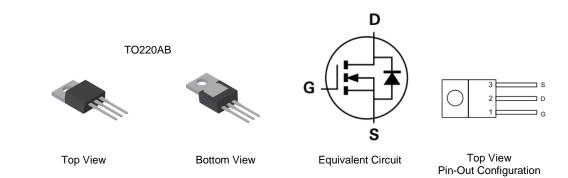
### 60V N-CHANNEL ENHANCEMENT MODE MOSFET

#### Features

- Excellent Q<sub>GD X</sub> R<sub>DS(ON)</sub> Product (FOM)
- Advanced Technology for DC-DC Converts
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

## **Mechanical Data**

- Case: TO220AB
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Terminals: Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Terminal Connections: See Diagram Below
- Weight: 1.85 grams (Approximate)



### Ordering Information (Note 4)

Part Number	Case	Packaging
DMT6009LCT	TO220AB	50 Pieces/Tube

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

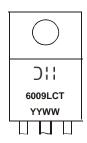
2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

### **Marking Information**

Notes:



) | |=Manufacturer's Marking 6009LCT = Product Type Marking CodeYYWW = Date Code Marking YY or <u>YY</u> = Last Digit of Year (ex: 16 = 2016) WW or <u>WW</u> = Week Code (01 to 53)



## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Drain-Source Voltage		V <sub>DSS</sub>	60	V
Gate-Source Voltage		V <sub>GSS</sub>	±16	V
Continuous Drain Current (Note 6) $V_{GS}$ = 10V	T <sub>C</sub> = +25°C T <sub>C</sub> = +100°C	ID	37.2 29.8	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I <sub>DM</sub>	80	A
Maximum Body Diode Forward Current (Note 6)		Is	80	A
Avalanche Current, L = 0.1mH		las	19.8	A
Avalanche Energy, L = 0.1mH		E <sub>AS</sub>	19.6	mJ

## **Thermal Characteristics**

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	PD	2.2	W
Thermal Resistance, Junction to Ambient (Note 5)		R <sub>0JA</sub>	55	°C/W
Total Power Dissipation (Note 6)	T <sub>C</sub> = +25°C	PD	25	W
Thermal Resistance, Junction to Case (Note 6)		R <sub>0JC</sub>	5	°C/W
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

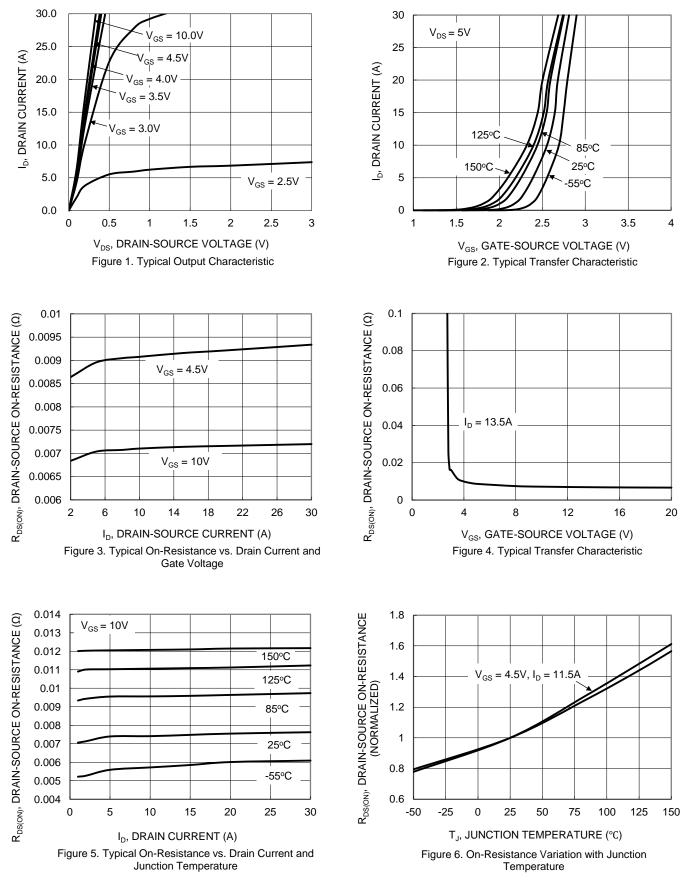
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)	Symbol	IVIIII	тур	INIAA	Unit	Test condition	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60			V	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250µA	
Zero Gate Voltage Drain Current	IDSS			1	μA	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage				±100	nA	$V_{\rm DS} = \pm 16V, V_{\rm DS} = 0V$ $V_{\rm GS} = \pm 16V, V_{\rm DS} = 0V$	
ON CHARACTERISTICS (Note 7)	I <sub>GSS</sub>			100		$VGS = \pm 10V, VDS = 0V$	
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.7		2	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
, ,		_	9.4	12	$V_{cc} = 10V$	$V_{GS} = 10V, I_D = 13.5A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>		7.6	14.5	mΩ	$V_{GS} = 4.5V, I_D = 11.5A$	
Diode Forward Voltage	V <sub>SD</sub>	_	_	1.2	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 8)						<u> </u>	
Input Capacitance	C <sub>ISS</sub>	_	1,925			$V_{DS} = 30V, f = 1MHz,$	
Output Capacitance	Coss	_	438	_	pF		
Reverse Transfer Capacitance	C <sub>RSS</sub>	_	41			$V_{GS} = 0V$	
Gate Resistance	R <sub>G</sub>		1.7		Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Q <sub>G</sub>	_	15.6				
Total Gate Charge (V <sub>GS</sub> = 10V)	Q <sub>G</sub>		33.5			$V_{DD} = 30V, I_D = 13.5A$	
Gate-Source Charge	Q <sub>GS</sub>		4.7		nC		
Gate-Drain Charge	Q <sub>GD</sub>		5.3				
Turn-On Delay Time	t <sub>D(ON)</sub>		4.5			$V_{DS} = 30V, V_{GS} = 10V,$ $R_G = 6\Omega, I_D = 13.5A$	
Turn-On Rise Time	t <sub>R</sub>		8.6				
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	35.9	—	ns		
Turn-Off Fall Time	tF	_	15.7	—	1		
Reverse Recovery Time	t <sub>RR</sub>	_	18.2		ns		
Reverse Recovery Charge	Q <sub>RR</sub>	_	33.1	_	nC	$I_F = 13.5A, di/dt = 100A/\mu s$	

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

Device mounted on an infinite heat sink.
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to production testing.



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DMT6009LCT Document number: DS38044 Rev. 1 - 2



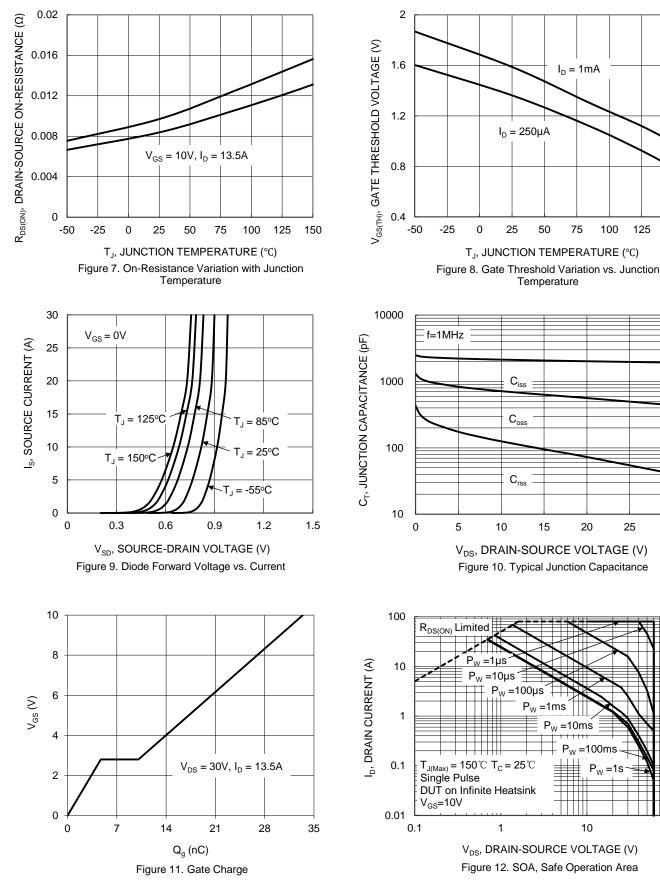
## DMT6009LCT

125

25

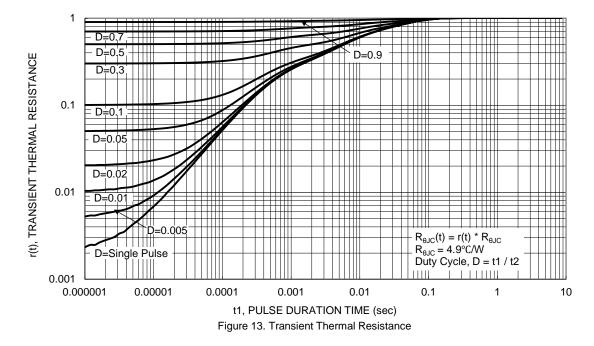
30

150



100

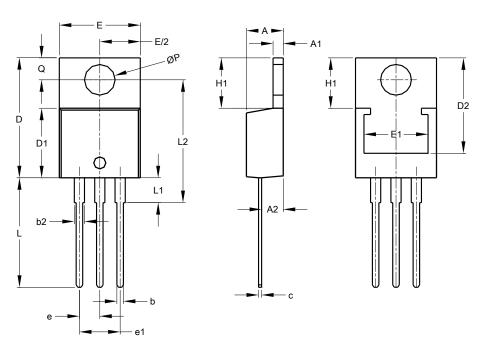






# Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



TO220AB

TO220AB					
Dim	Min	Max	Тур		
Α	3.56	4.82	Ι		
A1	0.51	1.39	-		
A2	2.04	2.92	_		
b	0.39	1.01	0.81		
b2	1.15	1.77	1.24		
С	0.356	0.61	-		
D	14.22	16.51	_		
D1	8.39	9.01	Ι		
D2	11.45	12.87	_		
е	-	Ι	2.54		
e1	-	-	5.08		
Е	9.66	10.66	Ι		
E1	6.86	8.89	_		
H1	5.85	6.85	Ι		
L	12.70	14.73	_		
L1	_	6.35	_		
L2	15.80	16.20	16.00		
Р	3.54	4.08	_		
Q	2.54	3.42	_		
All	All Dimensions in mm				



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